NOTICE OF	F REVISION (NOR) BEEN AUTHORIZED FOR TO	HE DOCUMENT LISTED	1. DATE (YYMMDD) 00/08/04	Form Approved OMB No. 0704-0188
Public reporting burden for this collection of information is existing data sources, gathering and maintaining the data burden estimate or any other aspect of this collection of Headquarters Services, Directorate for Information Operat	needed, and completing and reviewing information, including suggestions for re	he collection of information. Sen ducing this burden, to Departmen	d comments regarding nt of Defense, Washin	this gton ACTIVITY NO.
Treadypariers Services, Directorials on Information Operation Office of Management and Dudget. Paperson Reduction F TO EITHER OF THESE ADDRESSES. RETURN CL CONTRACT/PROCURING ACTIVITY NUMBER LISTED IN	ORM 3. DODAAC			
4. ORIGINATOR	o. ADDRESS (Street, City, Sta	te, Zip Code)	5. CAGE CODE	
a. TYPED NAME (First, Middle Initial, Last)	Post Office Box 3990		037Z3 7. CAGE CODE	5999-R004-00 8. DOCUMENT NO.
Defense Supply Center, Columbus	Columbus, OH 43216-5000		14933	85008
9. TITLE OF DOCUMENT		10. REVISION LETTER		11. ECP NO.
DELAY LINES, ACTIVE, 5 TAPS, 14-PIN TTL INTERFACED	DIP,	a. CURRENT E	b. NEW F	NONE
12. CONFIGURATION ITEM (OR SYSTEM)	TO WHICH ECP APPLIES	-	•	
12. CONFIGURATION ITEM (ON STOTEM)	TO WHICH LOF AFFLILD			
13. DESCRIPTION OF REVISION				
Page 1: Revisions letter column; add "F". Revisions description column; add Revisions date column; add "00/0		n NOR 5999-R004-00."		
Page 8: Table, delete CAGE "16714" and	all associated part numbers.			
Page 9: Delete CAGE "16714, Rhombus II	ndustries, Incorporated, 15801	Chemical Lane, Hunting	ton Beach, CA 92	2649, (714) 898-0960" as a
source of supply.				
14. THIS SECTION FOR GOVERNMENT US	SE ONLY			
	pplemented by this NOR may	be used in manufacture		
(2) Revised document m	ust be received before manufa	cturer may incorporate thi		
b. ACTIVITY AUTHORIZED TO APPROVE	document shall make above re CHANGE FOR GOVERNMEN			l. Last)
DSCC-VA		. O. THEO NAME (F	KENDALL A. CC	
d. TITLE	e. SIGNATURE			f. DATE SIGNED (YYMMDD)
CHIEF, ELECTRONIC COMPONENTS TEA	M Xull SA	July 3		00/08/04
15a. ACTIVITY ACCOMPLISHING REVISION	ON b. BEVISION COMPLET			c. DATE SIGNED (YYMMDD)
DSCC - VAT	$(\mathcal{L})$	( )( .		00/08/04

	REVISIONS	REVISIONS										
LTR	DESCRIPTION	DATE	APPROVED									
А	Added three sources for all dash numbers.	05 Sep 85	Ivan R. Jones									
В	Modified figure 1 and added footnotes. Added tables II and III. Deleted references to MIL-D-23859; substituted references to MIL-D-83532. Updated vendor table.	01 Jul 87	Randy Larson									
С	Changed standoff requirements in note 4 of figure 1.	19 Oct 87	Randy Larson									
D	Corrected I <sub>CCL</sub> max limit on table III. Added note 6 to figure 1. Changed pin length and added tolerances to pin dimensions. Added three vendors. Editorial changes throughout.	17 Aug 88	Randy Larson									
E	Changed 3.3. Moved output rise time data from table III to 3.6. Changed several dimensions on figure 1 and added notes 7 and 8. Deleted vendors 92912 and 56289.	21 Dec 92	Tony									

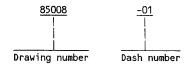
THE ORIGINAL FIRST PAGE OF THIS DRAWING HAS BEEN REPLACED.

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25 February	1700			CKED								TIT	LE									
	APPROVED BY Ivan R. Jones						DELAY LINES, ACTIVE, 5 TAPS, 14-PIN DIP, TTL INTERFACED					IP,										
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DESC FORM 144

JUL. 91 AMSC N/A

- 1. SCOPE
- 1.1 <u>Scope</u>. This drawing describes the requirements for a family of active 14-pin, 5 tap, TTL interfaced delay lines.
  - 1.2 Part or Identifying Number (PIN). The complete PIN shall be as shown in the following example:



- 2. APPLICABLE DOCUMENTS
- 2.1 Government documents.
- 2.1.1 <u>Government specifications and standards</u>. The following specifications and standards form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents shall be those listed in the issue of the Department of Defense Index of Specifications and Standards and supplement thereto, cited in the solicitation.

## **SPECIFICATIONS**

MILITARY

MIL-S-19491 - Semiconductor Devices, Packaging of.

MIL-M-38510 - Microcircuits, General Specification for.

MIL-D-83532 - Delay Lines, Active, General Specification for.

**STANDARDS** 

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

MIL-STD-1295 - Marking of Electrical and Electronic Parts.

(Copies of the specifications and standards required by contractors in connection with specific acquisition functions may be obtained from the DODSSP, Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

- 2.2 <u>Order of precedence</u>. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence. Nothing in this drawing, however, shall supersede applicable laws and regulations unless a specific exemption has been obtained.
  - 3. REQUIREMENTS
- 3.1 <u>Case material</u>. The case material shall be molded diallyl phthalate or encapsulated epoxy and be in accordance with MIL-D-83532.
  - 3.2 <u>Terminal material</u>. The terminal material shall be in accordance with MIL-M-38510.
  - 3.3 Integrated circuits (IC's). IC's shall meet the requirements of MIL-STD-883, level B, as a minimum.
  - 3.4 <u>Design and dimensions</u>. The design and dimensions shall be in accordance with figure 1 and table I.
- 3.5 <u>Delay times</u>. The delay times from input to all taps shall be as specified in table I ( $\pm$ 25°C) and table II ( $\pm$ 55°C and  $\pm$ 125°C).

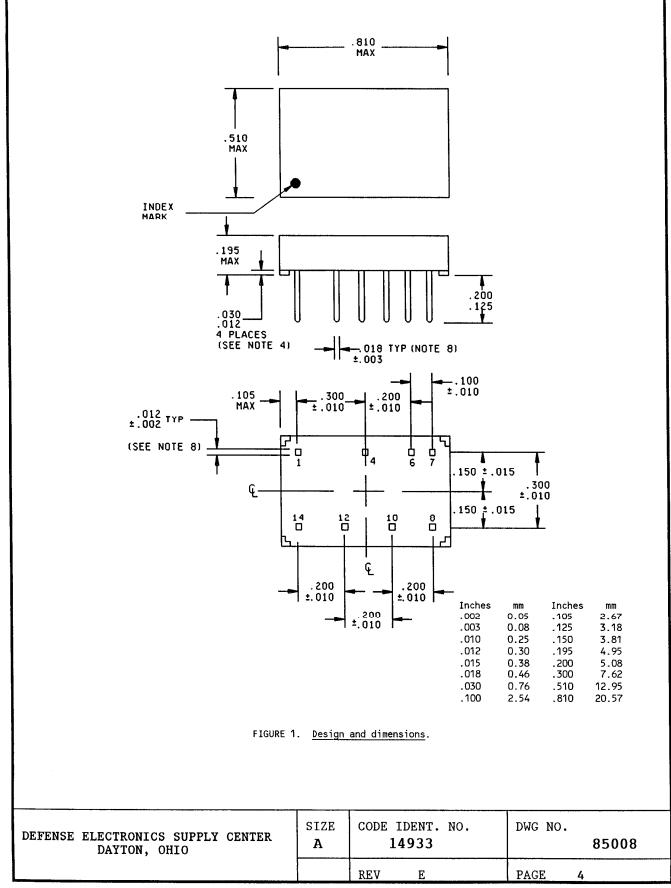
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 14933	DWG NO. 85008
		REV E	PAGE 2

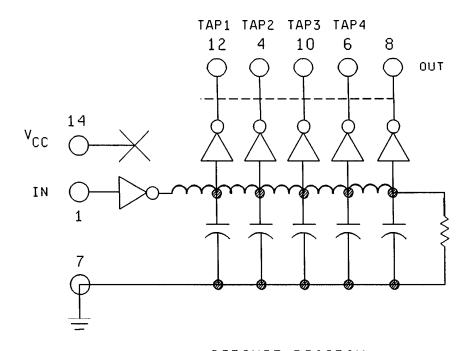
3.6 Output rise time. 4 ns maximum under the following conditions:

 $V_{CC}$  = 5.0 V;  $TR_I \le 3$  ns;  $C_L$  = 50 pF;  $R_L$  = 500 ohms. Applied to leading edge only.

- 5.7 <u>DC characteristics</u>. DC characteristics shall be as specified in table III.
- 3.8 Delay line fan-out. The delay line fan-out shall be 20 maximum (20 TTL loads per delay line).
- 3.9 Tap fan out. The tap fan out shall be 10/tap maximum (one tap is capable of driving 10 TTL load maximum).
- 3.10 Marking. Each delay line shall be marked on the top in accordance with method I of MIL-STD-1285 with the following information:
  - a. Complete PIN (see 1.2).
  - b. Index mark identification (over pin 1, input).
  - c. Manufacturer's Commercial and Government Entity (CAGE) code or logo.
  - d. Date code.
- 3.11 Workmanship. Parts shall be processed in such a manner as to be representative of controlled industrial techniques. Surfaces shall be free from burrs, die marks, chatter marks, scratches, dirt, grease, scale, splinters, and other defects that will affect life, serviceability, performance, or appearance. Visible parting line is acceptable.
- 3.12 <u>Certificate of compliance</u>. A certificate of compliance is required from each manufacturer requesting to be listed as a suggested source of supply (see 6.3). The certificate shall state that the manufacturer's product meets all the requirements of this drawing.
  - 4. QUALITY ASSURANCE PROVISIONS
  - 4.1 Quality conformance inspection.
- 4.1.1 <u>Inspection of product for delivery</u>. Inspection of product for delivery shall consist of compliance with group A inspection for level A of MIL-D-83532.
- 4.1.2 <u>Inspection of packaging</u>. The sampling and inspection of the preservation, packing, and container marking shall be in accordance with the requirements for semiconductor devices in MIL-S-19491.
  - PACKAGING
  - 5.1 <u>Packaging requirements</u>. The requirements for packaging shall be in accordance with MIL-S-19491.
  - 6 NOTES
- 6.1 <u>Intended use</u>. Devices conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application.
  - 6.2 Ordering data. The acquisition document should specify the following as a minimum:
    - a. Complete PIN (see 1.2).
    - b. Requirement for the manufacturer to include one copy of the quality conformance inspection data with each shipment of parts.
    - c. Requirement for the manufacturer to notify the acquiring activity in the event of a change in product.

DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 14933	DWG NO. 85008
		REV E	PAGE 3





## CIRCUIT DIAGRAM

## NOTES:

- 1. Dimensions are in inches.
- 2. Metric equivalents are given for general information only.
- 3. Unless otherwise specified, tolerance is  $\pm .005$  (0.13 mm).
- 4. Location and shape of standoffs are optional.5. Pins 2, 3, 5, 9, 11, and 13 may be omitted at the manufacturer's option.
- 6. Tolerances on dimensions separating leads are nonaccumulative.
- 7. Leads shall be free of case meniscus and other foreign material and shall be solderable for a minimum of .010 inch above the seating plane of the delay line.
- 8. Leads may be round at the discretion of the manufacturer. Round lead diameter shall be  $.020 \pm .002$ .

FIGURE 1. <u>Design and dimensions</u> - Continued.

DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE <b>A</b>	CODE IDENT. NO. 14933	DWG NO. 85008
		REV E	PAGE 5

TABLE I. Delay times at  $+25^{\circ}$ C,  $V_{CC} = 5.00 \pm .01 \text{ volts}$ .

PIN		Del	ay times in nan	oseconds	
85008-	Pin 12	Pin 4	Pin 10	Pin 6	Pin 8
	tap 1	tap 2	tap 3	tap 4	output
01	5 ±2 ns	10 ±2 ns	15 ±2 ns	20 ±2 ns	25 ±2 ns
02	6 ±2 ns	12 ±2 ns	18 ±2 ns	24 ±2 ns	30 ±2 ns
03	7 ±2 ns	14 ±2 ns	21 ±2 ns	28 ±2 ns	35 ±2 ns
04	8 ±2 ns	16 ±2 ns	24 ±2 ns	32 ±2 ns	40 ±2 ns
05	9 ±2 ns	18 ±2 ns	27 ±2 ns	36 ±2 ns	45 ±5%
06	10 ±2 ns	20 ±2 ns	30 ±2 ns	40 ±2 ns	50 ±5%
07	15 ±2 ns	30 ±2 ns	45 ±5%	60 ±5%	75 ±5%
08	20 ±2 ns	40 ±2 ns	60 ±5%	80 ±5%	100 ±5%
09	25 ±2 ns	50 ±5%	75 ±5%	100 ±5%	125 ±5%
10	30 ±2 ns	60 ±5%	90 ±5%	120 ±5%	150 ±5%
11 12 13 14	35 ±2 ns 40 ±2 ns 45 ±5% 50 ±5% 60 ±5%	70 ±5% 80 ±5% 90 ±5% 100 ±5% 120 ±5%	105 ±5% 120 ±5% 135 ±5% 150 ±5% 180 ±5%	140 ±5% 160 ±5% 180 ±5% 200 ±5% 240 ±5%	175 ±5% 200 ±5% 225 ±5% 250 ±5% 300 ±5%
16	70 ±5%	140 ±5%	210 ±5%	280 ±5%	350 ±5%
17	80 ±5%	160 ±5%	240 ±5%	320 ±5%	400 ±5%
18	90 ±5%	180 ±5%	270 ±5%	360 ±5%	450 ±5%
19	100 ±5%	200 ±5%	300 ±5%	400 ±5%	500 ±5%

TABLE II. Delay times at -55°C and +125°C,  $V_{CC} = 5.00 \pm .01$  volts.

PIN		Delay	times in nanosed	conds	
85008-	Pin 12	Pin 4	Pin 10	Pin 6	Pin 8
	tap 1	tap 2	tap 3	tap 4	output
01	5 ±3 ns	10 ±3 ns	15 ±3 ns	20 ±3 ns	25 ±3 ns
02	6 ±3 ns	12 ±3 ns	18 ±3 ns	24 ±3 ns	30 ±3 ns
03	7 ±3 ns	14 ±3 ns	21 ±3 ns	28 ±3 ns	35 ±3 ns
04	8 ±3 ns	16 ±3 ns	24 ±3 ns	32 ±3 ns	40 ±3 ns
05	9 ±3 ns	18 ±3 ns	27 ±3 ns	36 ±3 ns	45 ±8%
06	10 ±3 ns	20 ±3 ns	30 ±3 ns	40 ±3 ns	50 ±8%
07	15 ±3 ns	30 ±3 ns	45 ±8%	60 ±8%	75 ±8%
08	20 ±3 ns	40 ±3 ns	60 ±8%	80 ±8%	100 ±8%
09	25 ±3 ns	50 ±8%	75 ±8%	100 ±8%	125 ±8%
10	30 ±3 ns	60 ±8%	90 ±8%	120 ±8%	150 ±8%
11	35 ±3 ns	70 ±8%	105 ±8%	140 ±8%	175 ±8%
12	40 ±3 ns	80 ±8%	120 ±8%	160 ±8%	200 ±8%
13	45 ±8%	90 ±8%	135 ±8%	180 ±8%	225 ±8%
14	50 ±8%	100 ±8%	150 ±8%	200 ±8%	250 ±8%
15	60 ±8%	120 ±8%	180 ±8%	240 ±8%	300 ±8%
16	70 ±8%	140 ±8%	210 ±8%	280 ±8%	350 ±8%
17	80 ±8%	160 ±8%	240 ±8%	320 ±8%	400 ±8%
18	90 ±10%	180 ±8%	270 ±8%	360 ±8%	450 ±8%
19	100 ±10%	200 ±8%	300 ±8%	400 ±8%	500 ±8%

DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 14933	DWG NO. 85008
		REV E	PAGE 6

TABLE III. <u>DC characteristics</u>.

Test	Symbol	Conditions	Lim	its	Unit
		-55°C ≤ T <sub>C</sub> ≤ +125°C	Min	Max	
High level output voltage	V <sub>ОН</sub>	ν <sub>cc</sub> = 4 5 ν VIH = 2.0 ν I <sub>OH</sub> = -1 mA	2.5		V
Low level output voltage	V <sub>OL</sub>	$v_{CC} = 4.5 \text{ V}$ $VIL = 0.8 \text{ V}$ $I_{OL} = 20 \text{ mA}$		.5	V
Input clamp voltage	v <sub>IC</sub>	V <sub>CC</sub> - 4.5 V I <sub>I</sub> = -18 mA T <sub>C</sub> = +25°C		1.2	V
High level input current	I IH1	v <sub>CC</sub> = 5.5 v, v <sub>IH</sub> = 2.7 v		50	μΑ
	I <sub>IH2</sub>	v <sub>cc</sub> = 5.5 v, v <sub>IH</sub> = 5.5 v		1000	μA
Low level input current	IIL	v <sub>cc</sub> = 5.5 v, v <sub>IL</sub> = .5 v		-2.00	mA
Short circuit output current	I <sub>OS</sub>	V <sub>CC</sub> = 5.5 V, V <sub>OS</sub> = 0.0 V Not more than one output shorted at a time	-40	-150	mA
Low level supply current	<sup>I</sup> CCL	v <sub>cc</sub> = 5.5 v v <sub>I</sub> = 0.0 v		75	mA

DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 14933	DWG NO. 85008
		REV E	PAGE 7

6.3 <u>Suggested sources of supply</u>. Suggested sources of supply are listed below. Additional sources will be added as they become available. This table is not a qualified products list or an approved source list. The vendors indicated have submitted certificates of compliance to DESC; however, parts may be ordered from any manufacturer who agrees to supply components which conform to all the requirements of this drawing.

		Sim	ilar vendor PIN	and CAGE	code 1/	
DESC PIN 85008-	00222	50965	22519	20933	16714	62694
01	9T25\$	4508-01	DDU6-8512-1	00T204	DSP00801	L-13-904
02	9T30s	4508-02	DDU6-8512-2	00т205	DSP008-02	L-13-905
03	9T35S	4508-03	DDU6-8512-3	00т206	DSP008-03	L-13-906
04	9T40s	4508-04	DDU6-8512-4	00т207	DSP008-04	L-13-907
05	9T45S	4508-05	DDU6-8512-5	00Т208	DSP008-05	L-13-908
06	9T50s	4508-06	DDU6-8512-6	00т209	DSP008-06	L-13-909
07	9T75S	4508-07	DDU6-8512-7	00т210	DSP008-07	L-13-910
08	9T100s	4508-08	DDU6-8512-8	10т363	DSP008-08	L-13-911
09	9T125S	4508-09	DDU6-8512-9	10т364	DSP008-09	L-13-912
10	9T150s	4508-10	DDU6-8512-10	10т365	DSP008-10	L-13-913
11	9T1758	4508-11	DDU6-8512-11	10т366	DSP008-11	L-13-914
12	9T200s	4508-12	DDU6-8512-12	10т367	DSP008-12	L-13-915
13	9T225S	4508-13	DDU6-8512-13	10T368	DSP008-13	L-13-916
14	9T250S	4508-14	DDU6-8512-14	10T369	DSP008-14	L-13-917
15	9T300S	4508-15	DDU6-8512-15	10т370	DSP008-15	L-13-918
16	9T350s	4508-16	DDU6-8512-16	10т371	DSP008-16	L-13-919
17	9T400S	4508-17	DDU6-8512-17	10т372	DSP008-17	L-13-920
18	9T450S	4508-18	DDU6-8512-18	10Т373	DSP008-18	L-13-921
19	9T500s	4508-19	DDU6-8512-19	10т374	DSP008-19	L-13-922

 $<sup>\</sup>underline{1}/$  CAUTION: Vendor PIN's are provided for reference purposes only. Do not use these numbers for item acquisition and marking.

DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 14933	DWG NO. 85008
		REV E	PAGE 8

Vendor CAGE	Vendor name	
number	and address	
00222	ESC Electronics Corporation 534 Bergen Boulevard Palisades Park, NJ 07650 (201) 947-0400	
16714	Rhombus Industries, Incorporated 15801 Chemical Lane Huntington Beach, CA 92649 (714) 898-0960	
20933	Kappa Technologies, Incorporated 1443 Pinewood Street Rahway, NJ 07065 (908) 396-9400	
22519	Data Delay Devices, Incorporated 3 Mt. Prospect Avenue Clifton, NJ 07013 (201) 773-2299	
50965	Princeton Advanced Components, Incorporated 860 State Road Princeton, NJ 08540 (609) 924-2444	
62694	JBM Electronics 1 Commerce Drive Bedford, NH 03110 (603) 623-0222	

6.4 <u>Assistance</u>. Questions or comments concerning this drawing should be referred to DESC-EMM, 1507 Wilmington Pike, Dayton, OH 45444-5270, telephone (513) 296-5255.

DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 14933	DWG NO. 85008
		REV E	PAGE 9